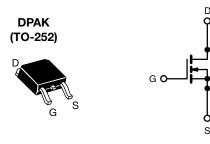
# SiHD6N65E

**Vishay Siliconix** 



# **E Series Power MOSFET**

PRODUCT SUMMARY			
V <sub>DS</sub> (V) at T <sub>J</sub> max.	700		
R <sub>DS(on)</sub> max. at 25 °C (Ω)	$V_{GS} = 10 V$	0.6	
Q <sub>g</sub> max. (nC)	48		
Q <sub>gs</sub> (nC)	6		
Q <sub>gd</sub> (nC)	11		
Configuration	Single		



N-Channel MOSFET

### FEATURES

- Low figure-of-merit (FOM) Ron x Qg
- Low input capacitance (Ciss)
- Reduced switching and conduction losses
- Ultra low gate charge (Q<sub>q</sub>)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

### APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
  - High-intensity discharge (HID)
  - Fluorescent ballast lighting
- Industrial
  - Welding
  - Induction heating
  - Motor drives
  - Battery chargers
  - Renewable energy
  - Solar (PV inverters)

ORDERING INFORMATION			
Package	DPAK (TO-252)		
	SiHD6N65E-GE3		
Lood (Db) free and Lielenen free	SiHD6N65ET1-GE3		
Lead (Pb)-free and Halogen-free	SiHD6N65ET4-GE3		
	SiHD6N65ET5-GE3		

ABSOLUTE MAXIMUM RATINGS (T <sub>C</sub> :	= 25 °C, unl	ess otherwis	se noted)			
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V <sub>DS</sub>	650	v	
Gate-Source Voltage			V <sub>GS</sub>	± 30	v	
Continuous Drain Current (T. 150 °C)	$\lambda$ at 10 $\lambda$	T <sub>C</sub> = 25 °C T <sub>C</sub> = 100 °C		7		
Continuous Drain Current (T <sub>J</sub> = 150 °C)	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 100 °C	I <sub>D</sub>	5	А	
Pulsed Drain Current <sup>a</sup>			I <sub>DM</sub>	18		
Linear Derating Factor				0.63	W/°C	
Single Pulse Avalanche Energy <sup>b</sup>			E <sub>AS</sub>	56	mJ	
Maximum Power Dissipation			PD	78	W	
Operating Junction and Storage Temperature Range			T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C	
Drain-Source Voltage Slope $T_J = 125 \text{ °C}$		dV/dt	37			
Reverse Diode dV/dt <sup>d</sup>			27	V/ns		
Soldering Recommendations (Peak Temperature) <sup>c</sup> for 10 s			300	°C		

### Notes

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a. Repetitive rating; pulse width limited by maximum junction temperature.

b.  $V_{DD}$  = 50 V, starting  $T_J$  = 25 °C, L = 28.2 mH,  $R_g$  = 25  $\Omega,$   $I_{AS}$  = 2 A.

c. 1.6 mm from case.

d.  $I_{SD} \leq I_D,\,dI/dt$  = 100 A/µs, starting  $T_J$  = 25 °C.

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COMPLIANT HALOGEN

FREE

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# SiHD6N65E

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PARAMETER	SYMBOL	TYP.	MAX	<b>(</b> .		UNIT	
Maximum Junction-to-Ambient	R <sub>thJA</sub>	- 62 - 1.6					
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>				°C/W		
<b>SPECIFICATIONS</b> ( $T_J = 25 \ ^{\circ}C_{,1}$	unless otherw	ise noted)					
PARAMETER	SYMBOL	1	CONDITIONS	MIN.	TYP.	MAX.	UNI
Static							1
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>GS</sub> =	= 0 V, I <sub>D</sub> = 250 μA	650	-	-	V
V <sub>DS</sub> Temperature Coefficient	ΔV <sub>DS</sub> /T <sub>J</sub>		e to 25 °C, I <sub>D</sub> = 1 mA	-	0.73	-	V/°C
Gate-Source Threshold Voltage (N)	V <sub>GS(th)</sub>		= V <sub>GS</sub> , I <sub>D</sub> = 250 μA	2	-	4	V
	GO(iii)		$V_{GS} = \pm 20 \text{ V}$	-	-	± 100	nA
Gate-Source Leakage	I <sub>GSS</sub>		$V_{GS} = \pm 30 \text{ V}$	-	-	± 1	μA
	1.		= 650 V, V <sub>GS</sub> = 0 V	-	-	1	<u>р</u> и (
Zero Gate Voltage Drain Current	I <sub>DSS</sub>		$V_{DS} = 530 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$ $V_{DS} = 520 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 125 \text{ °C}$		- 1	10	μA
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	$I_D = 3 A$	-	0.5	0.6	Ω
Forward Transconductance	g <sub>fs</sub>		= 30 V, I <sub>D</sub> = 3 A	-	2	-	S
Dynamic	4				ļ	Į	1
Input Capacitance	C <sub>iss</sub>	V <sub>GS</sub> = 0 V,		-	820	-	
Output Capacitance	C <sub>oss</sub>		$v_{GS} = 0 V,$ $V_{DS} = 100 V,$		40	-	
Reverse Transfer Capacitance	C <sub>rss</sub>	f = 1 MHz		-	4	-	
Effective Output Capacitance, Energy Related <sup>a</sup>	C <sub>o(er)</sub>	V. 0.V. 500.V.V. 0.V.		-	36	-	pF
Effective Output Capacitance, Time Related <sup>b</sup>	C <sub>o(tr)</sub>	$ V_{DS} = 0$ V	$V_{DS}$ = 0 V to 520 V, $V_{GS}$ = 0 V		117	-	1
Total Gate Charge	Qg			-	24	48	nC
Gate-Source Charge	Q <sub>gs</sub>	$V_{GS} = 10 V$	$I_D = 3 \text{ A}, V_{DS} = 520 \text{ V}$	-	6	-	
Gate-Drain Charge	Q <sub>gd</sub>			-	11	-	
Turn-On Delay Time	t <sub>d(on)</sub>			-	14	28	
Rise Time	t <sub>r</sub>	Voo	= 520 V, I <sub>D</sub> = 3 A,	-	12	24	-
Turn-Off Delay Time	t <sub>d(off)</sub>	V <sub>GS</sub> =	$= 10 \text{ V}, \text{ R}_{g} = 9.1 \Omega$	-	30	60	ns
Fall Time	t <sub>f</sub>			-	20	40	
Gate Input Resistance	R <sub>g</sub>	f = 1	MHz, open drain	-	1.4	-	Ω
Drain-Source Body Diode Characterist	ics						
Continuous Source-Drain Diode Current	I <sub>S</sub>	MOSFET syml showing the	MOSFET symbol showing the		-	7	^
Pulsed Diode Forward Current	I <sub>SM</sub>	integral reverse p - n junction diode		-	-	18	— A
Diode Forward Voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °	C, I <sub>S</sub> = 3 A, V <sub>GS</sub> = 0 V	-	-	1.3	V
Reverse Recovery Time	t <sub>rr</sub>			-	237	-	ns
Reverse Recovery Charge	Q <sub>rr</sub>	$T_J = 25 \text{ °C}, I_F = I_S = 3 \text{ A},$ dI/dt = 100 A/ $\mu$ s, V <sub>R</sub> = 25 V		-	2.2	-	μC
Reverse Recovery Current	I <sub>RRM</sub>			-	16		A

#### Notes

a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ .

b.  $C_{oss(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ .

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## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

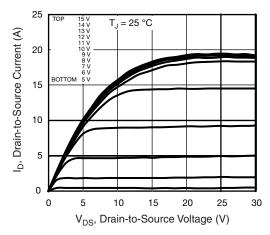


Fig. 1 - Typical Output Characteristics

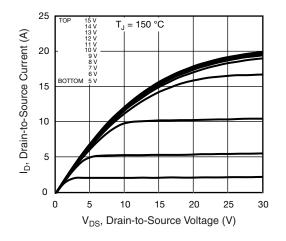


Fig. 2 - Typical Output Characteristics

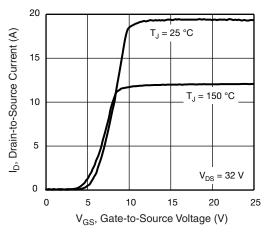


Fig. 3 - Typical Transfer Characteristics

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3 R<sub>DS(on)</sub>, Drain-to-Source On Resistance (Normalized) 2.5 2 1.5  $V_{GS}$ 10 V 0.5 0 - 60 - 40 - 20 0 20 40 60 80 100 120 140 160 T<sub>J</sub>, Junction Temperature (°C)

Fig. 4 - Normalized On-Resistance vs. Temperature

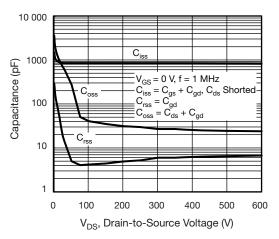
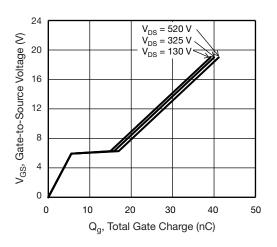


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage





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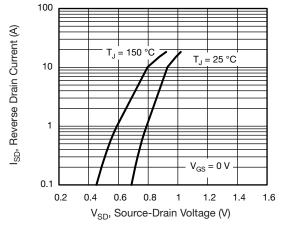


Fig. 7 - Typical Source-Drain Diode Forward Voltage

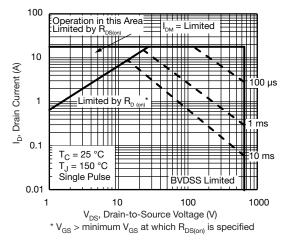


Fig. 8 - Maximum Safe Operating Area

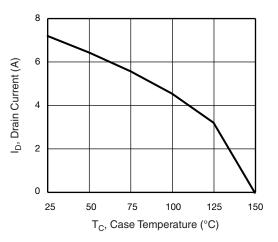


Fig. 9 - Maximum Drain Current vs. Case Temperature

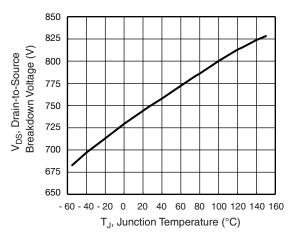
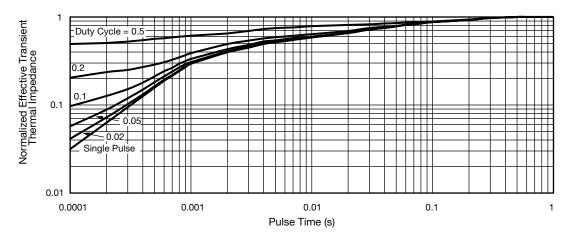


Fig. 10 - Temperature vs. Drain-to-Source Voltage





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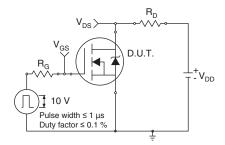


Fig. 12 - Switching Time Test Circuit

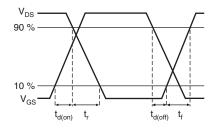


Fig. 13 - Switching Time Waveforms

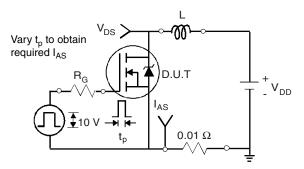


Fig. 14 - Unclamped Inductive Test Circuit

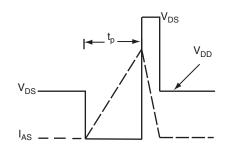


Fig. 15 - Unclamped Inductive Waveforms

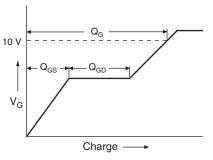


Fig. 16 - Basic Gate Charge Waveform

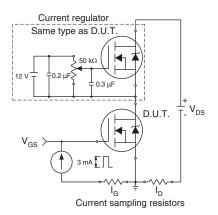


Fig. 17 - Gate Charge Test Circuit

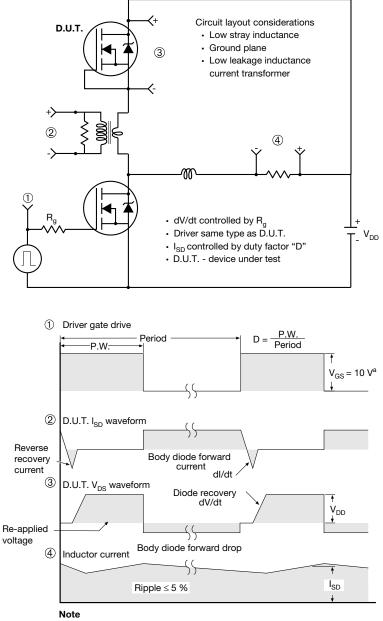
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#### Peak Diode Recovery dV/dt Test Circuit



a.  $V_{GS} = 5 V$  for logic level devices

Fig. 18 - For N-Channel

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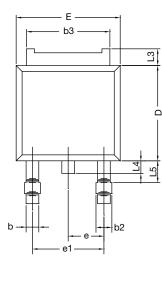
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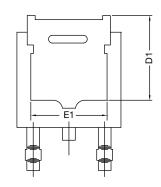


## **TO-252AA Case Outline**

### VERSION 1: FACILITY CODE = Y







	MILLIMETERS		
DIM.	MIN.	MAX.	
А	2.18	2.38	
A1	-	0.127	
b	0.64	0.88	
b2	0.76	1.14	
b3	4.95	5.46	
С	0.46	0.61	
C2	0.46	0.89	
D	5.97	6.22	
D1	4.10	-	
E	6.35	6.73	
E1	4.32	-	
Н	9.40	10.41	
е	2.28	BSC	
e1	4.56 BSC		
L	1.40	1.78	
L3	0.89	1.27	
L4	-	1.02	
L5	1.01	1.52	

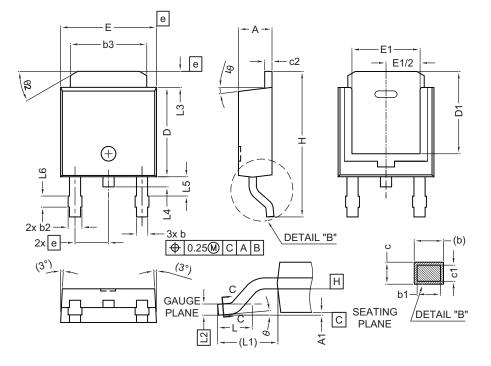
#### Note

Dimension L3 is for reference only



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### VERSION 2: FACILITY CODE = N



	MILLIMETERS		
DIM.	MIN.	MAX.	
A	2.18	2.39	
A1	-	0.13	
b	0.65	0.89	
b1	0.64	0.79	
b2	0.76	1.13	
b3	4.95	5.46	
с	0.46	0.61	
c1	0.41	0.56	
c2	0.46	0.60	
D	5.97	6.22	
D1	5.21	-	
E	6.35	6.73	
E1	4.32	-	
e	2.29 BSC		
Н	9.94	10.34	

	MILLIMETERS		
DIM.	MIN.	MAX.	
L	1.50	1.78	
L1	2.74	1 ref.	
L2	0.51	BSC	
L3	0.89	1.27	
L4	-	1.02	
L5	1.14	1.49	
L6	0.65	0.85	
θ	0°	10°	
θ1	0°	15°	
θ2	25°	35°	

#### Notes

Dimensioning and tolerance confirm to ASME Y14.5M-1994

All dimensions are in millimeters. Angles are in degrees

Heat sink side flash is max. 0.8 mm

Radius on terminal is optional ٠

ECN: E19-0649-Rev. Q, 16-Dec-2019 DWG: 5347

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## **RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)**



Recommended Minimum Pads Dimensions in Inches/(mm)

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